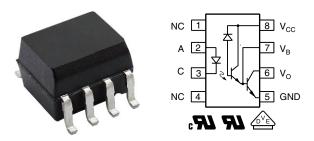


High Speed Optocoupler, 100 kBd, Low Input Current, High Gain



FEATURES

- High current transfer ratio, 300 %
- · Low input current, 0.5 mA
- High output current, 60 mA
- TTL compatible output, V_{OL} = 0.1 V
- Adjustable bandwidth access to base

 Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





LINKS TO ADDITIONAL RESOURCES







DESCRIPTION

The SFH6319 is best suited for low power logic applications involving CMOS and low power TTL. A 400 % current transfer ratio with only 0.5 mA of LED current is guaranteed from 0 $^{\circ}$ C to 70 $^{\circ}$ C.

Very high current ratio together with 4000 V_{RMS} isolation are achieved by coupling an LED with an integrated high gain photo detector in a SOIC-8 package. Separate pins for the photo diode and output stage enable TTL compatible saturation voltages with high speed operation. Photodarlington operation is achieved by tying the V_{CC} and V_{O} terminals together. Access to the base terminal allows adjustment to the gain bandwidth.

APPLICATIONS

- Logic ground isolation TTL / TTL, TTL / CMOS, CMOS / CMOS, CMOS / TTL
- EIA RS 232C line receiver
- · Low input current line receiver long lines, party lines
- Telephone ring detector
- Line voltage status indication low input power dissipation
- · Low power systems ground isolation

AGENCY APPROVALS

- UL
- cUL
- DIN EN 60747-5-5 (VDE 0884-5), available with option 1

ORDERING INFORMATION			
S F H 6 3 1 PART NUMBER	9 - X 0 # # T PACKAGE OPTION TAPE AND REEL		
AGENCY CERTIFIED / PACKAGE	CTR (%)		
UL, cUL	≥ 500		
SOIC-8	SFH6319T		

Note

· Additional options may be possible, please contact sales office



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Vishay Semiconductors

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
INPUT		<u> </u>				
Reverse voltage		V_R	3	V		
Supply and output voltage	V _{CC} (pin 8 to 5), V _O (pin 6 to 5)	V _{CC} , V _O	-0.5 to 18	V		
Input power dissipation		P _{diss}	35	mW		
Average input current		I _{F(AVG)}	20	mA		
Peak input current	50 % duty cycle; 1 ms pulse width	I _{FRM}	40	mA		
Peak transient input current	t _p ≤ 1 μs, 300 pps	I _{FSM}	1	Α		
OUTPUT		<u> </u>				
Output current (pin 6)		Io	60	mA		
Emitter-base reverse current (pin 5 to 7)		V _{EB0}	0.5	V		
Output power dissipation		P _{diss}	150	mW		
Derate linearly from 25 °C			2	mW/°C		
COUPLER		<u> </u>				
Storage temperature		T _{stg}	-55 to +125	°C		
Lead soldering temperature	t = 10 s	T _{sld}	260	°C		
Junction temperature		Tj	125	°C		
Ambient temperature range		T _{amb}	-55 to +100	°C		
Total power dissipation		P _{diss}	185	mW		

Note

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.

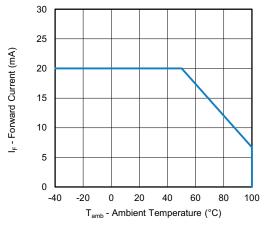


Fig. 1 - Forward Current vs. Ambient Temperature

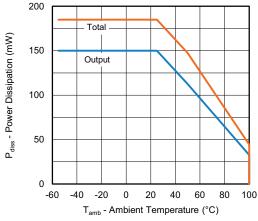


Fig. 2 - Power Dissipation vs. Ambient Temperature



ELECTRICAL CHARACTERISTICS (T _{amb} = 0 °C to 70 °C; typical values are at T _{amb} = 25 °C)							
PARAMETER	TEST CONDITION SYMBO		MIN.	TYP.	MAX.	UNIT	
INPUT	INPUT						
Forward voltage	I _F = 1.6 mA	V_{F}	-	1.28	1.7	V	
Temperature coefficient of forward voltage	I _F = 1.6 mA	$\Delta V_F / \Delta T_{amb}$	-	-2.3	-	mV/°C	
Input capacitance	$f = 1 \text{ MHz}, V_F = 0$	C _{IN}	-	55	-	pF	
OUTPUT							
	$I_F = 1.6 \text{ mA}, I_O = 4.8 \text{ mA}, V_{CC} = 4.5 \text{ V}$	V_{OL}	-	0.1	0.4	V	
Logic low output voltage (1)	$I_F = 1.6 \text{ mA}, I_O = 8 \text{ mA}, V_{CC} = 4.5 \text{ V}$	V_{OL}	-	0.1	0.4	V	
Logic low output voltage (*)	$I_F = 5 \text{ mA}, I_O = 15 \text{ mA}, V_{CC} = 4.5 \text{ V}$	V_{OL}	-	0.15	0.4	V	
	$I_F = 12 \text{ mA}, I_O = 24 \text{ mA}, V_{CC} = 4.5 \text{ V}$	V_{OL}	-	0.25	0.4	V	
Logic high output current (1)	$I_F = 0 \text{ mA}, V_O = V_{CC} = 7 \text{ V}$	I _{IO}	-	0.1	250	μΑ	
Logic high output current (*)	$I_F = 0 \text{ mA}, V_O = V_{CC} = 18 \text{ V}$	I _{IO}	-	0.05	100	μA	
Logic low supply current (1)	$I_F = 1.6 \text{ mA}, V_O = \text{OPEN}, V_{CC} = 18 \text{ V}$	I _{CCL}	-	0.3	1.5	mA	
Logic high supply current (1)	$I_F = 0$ mA, $V_O = OPEN$, $V_{CC} = 18$ V	I _{CCH}	-	0.0003	10	μA	
COUPLER							
Capacitance (input to output) (2)	f = 1 MHz	C _{IO}	-	0.6	-	pF	

Notes

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering
 evaluation. Typical values are for information only and are not part of the testing requirements.
- (1) Pin 7 open
- (2) Device considered a two-terminal device: pins 1, 2, 3, and 4 shorted together and pins 5, 6, 7, and 8 shorted together

CURRENT TRANSFER RATIO (T _{amb} = 0 °C to 70 °C; typical values are at T _{amb} = 25 °C)						
PARAMETER TEST CONDITION SYMBOL MIN. TYP. MAX. UN				UNIT		
Current transfer ratio (1)	$I_F = 0.5 \text{ mA}, V_O = 0.4 \text{ V}, V_{CC} = 4.5 \text{ V}$	CTR	400	2200	3500	%
Current transfer ratio (7)	$I_F = 1.6 \text{ mA}, V_O = 0.4 \text{ V}, V_{CC} = 4.5 \text{ V}$	CTR	500	2000	2600	%

Notes

DC current transfer ratio is defined as the ratio of output collector current, I_O, to the forward LED input current, I_F times 100 %

⁽¹⁾ Pin 7 open

SWITCHING CHARACTERISTICS (T _{amb} = 25 °C)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Propagation delay time to low output level (1)(2)	$I_F = 0.5 \text{ mA}, R_L = 4.7 \text{ k}\Omega$	t _{PHL}	-	4	25	μs
Propagation delay time to high output level (1)(2)	I_F = 12 mA, R_L = 270 Ω	t _{PHL}	-	0.5	1	μs
Propagation delay time to high output level (1)(2)	$I_F = 0.5 \text{ mA}, R_L = 4.7 \text{ k}\Omega$	t _{PLH}	-	30	60	μs
Propagation delay time to high output level (1)(2)	$I_F = 12 \text{ mA}, R_L = 270 \Omega$	t _{PLH}	-	3	7	μs

Notes

- (1) Pin 7 open
- (2) Using a resistor between pin 5 and 7 will decrease gain and delay time



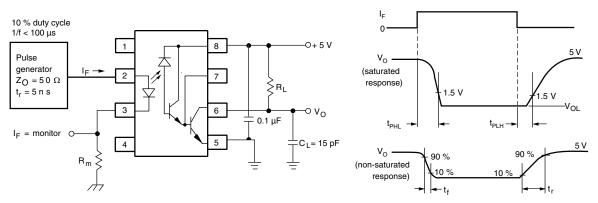


Fig. 3 - Switching Test Circuit

COMMON MODE TRANSIENT IMMUNITY (T _{amb} = 25 °C)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Common mode transient immunity at logic high level output (1)(2)	$I_{F} = 0 \text{ mA, } R_{L} = 2.2 \text{ k}\Omega,$ $V_{CM} = 10 \text{ V}_{PP}$	CM _H	-	1000	-	V/µs
Common mode transient immunity at logic low level output (1)(2)	$I_F = 1.6 \text{ mA}, \ R_L = 2.2 \text{ k}\Omega, \\ V_{CM} = 10 \ V_{PP}$	CM _L	-	1000	-	V/µs

Notes

- (1) Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{cm}/dt on the leading edge of the common mode pulse, V_{CM}, to assure that the output will remain in a logic high state (i.e. V_O > 2 V) common mode transient immunity in logic low level is the maximum tolerable (negative) dV_{cm}/dt on the trailing edge of the common mode pulse signal, V_{CM}, to assure that the output will remain in a logic low state (i.e. V_O < 0.8 V)</p>
- (2) In applications where dv/dt may exceed 50 000 V/µs (such as state discharge) a series resistor, R_{CC} should be included to protect I_C from destructively high surge currents. The recommended value is refer to Fig. 2.
 R_{CC} ≅ [IV/(0.15 x I_F (mA))] kΩ.

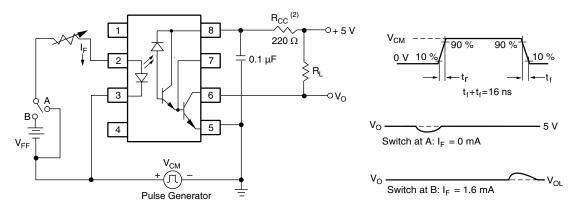


Fig. 4 - Test Circuit for Transient Immunity and Typical Waveforms



SAFETY AND INSULATION RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Climatic classification	According to IEC 68 part 1		55 / 100 / 21				
Pollution degree	According to DIN VDE 0109		2				
Comparative tracking index	Insulation group IIIa	CTI	175				
Maximum rated withstanding isolation voltage	According to UL1577, t = 1 min	V _{ISO}	3333	V _{RMS}			
Tested withstanding isolation voltage	According to UL1577, t = 1 s	V _{ISO}	4000	V _{RMS}			
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V _{IOTM}	6000	V _{peak}			
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V _{IORM}	560	V _{peak}			
	$V_{IO} = 500 \text{ V}, T_{amb} = 25 ^{\circ}\text{C}$	R _{IO}	≥ 10 ¹²	Ω			
Isolation resistance	V _{IO} = 500 V, T _{amb} = 100 °C	R _{IO}	≥ 10 ¹¹	Ω			
	$V_{IO} = 500 \text{ V}, T_{amb} = T_{S}$	R _{IO}	≥ 10 ⁹	Ω			
Output safety power		P_{SO}	350	mW			
Input safety current		I _{SI}	150	mA			
Safety temperature		T _S	165	°C			
Creepage distance			≥ 4	mm			
Clearance distance			≥ 4	mm			
Insulation thickness		DTI	≥ 0.3	mm			
Input to output test voltage, method B	V_{IORM} x 1.875 = V_{PR} , 100 % production test with t_M = 1 s, partial discharge < 5 pC	V_{PR}	1050	V _{peak}			
Input to output test voltage, method A	V_{IORM} x 1.6 = V_{PR} , 100 % sample test with t_{M} = 10 s, partial discharge < 5 pC	V_{PR}	896	V _{peak}			

Note

• As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

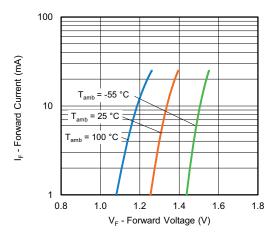


Fig. 5 - Forward Current vs. Forward Voltage

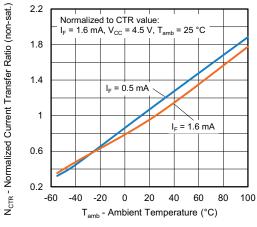


Fig. 6 - Normalized Current Transfer Ratio (non-saturated) vs.

Ambient Temperature

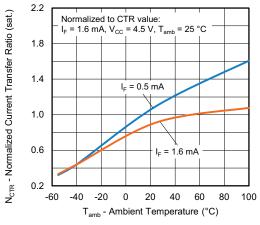


Fig. 7 - Normalized Current Transfer Ratio (saturated) vs.
Ambient Temperature

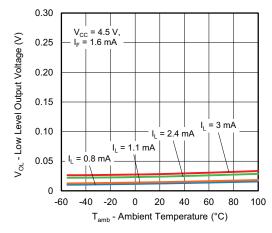


Fig. 8 - Low Level Output Voltage vs. Ambient Temperature

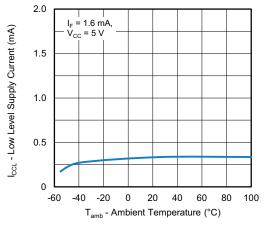
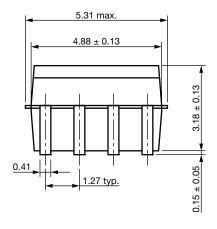
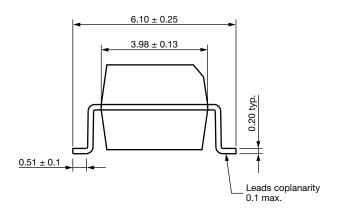


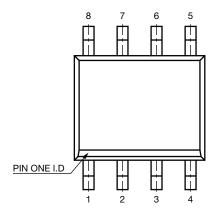
Fig. 9 - Low Level Supply Current vs. Ambient Temperature



PACKAGE DIMENSIONS (in millimeters)









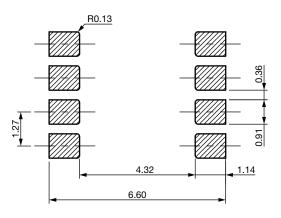


Fig. 10 - Package Drawing

PACKAGE MARKING

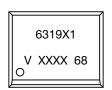


Fig. 11 - Example of SFH6319-X001T

Notes

- XXXX = LMC (lot marking code)
- "X1" is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking

PACKING INFORMATION (in millimeters)

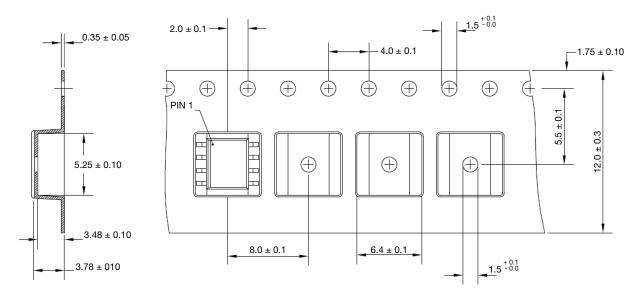


Fig. 12 - Tape and Reel Packing (2000 pieces on reel)

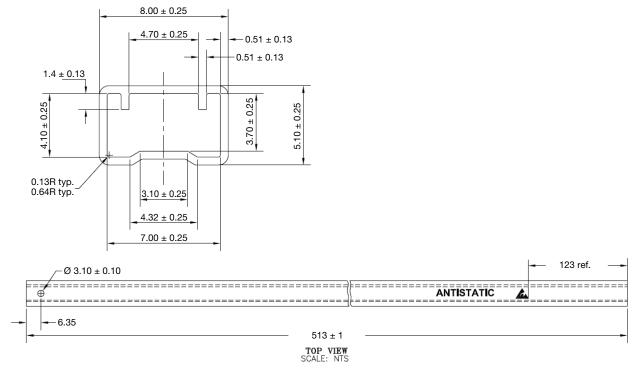


Fig. 13 - Tube Packing

DEVICE PER TUBE					
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX		
SOIC-8	100	30	3000		



SOLDER PROFILE

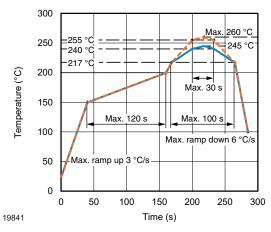


Fig. 14 - Lead (Pb)-free Reflow Solder Profile according to J-STD-020

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2 Floor life: unlimited

Conditions: T_{amb} < 30 °C, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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